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ABSTRACT
Strain engineering in Sn-rich group IV semiconductors is a key enabling factor to exploit the direct bandgap at mid-infrared wavelengths. Here, we investigate the effect of strain on the growth of GeSn alloys in a Ge/GeSn core/shell nanowire geometry by controlling the Ge core diameter and correlating the results with theoretical strain calculations. Incorporation of the Sn content in the 10–20 at. % range is achieved with Ge core diameters ranging from 50 nm to 100 nm. While the smaller cores lead to the formation of a regular and homogeneous GeSn shell, larger cores lead to the formation of multifaceted sidewalls and broadened segregation domains, inducing the nucleation of defects. This behavior is rationalized in terms of the different residual strain, as obtained by realistic finite element method simulations. The extended analysis of the strain relaxation as a function of core and shell sizes, in comparison with the conventional planar geometry, provides a deeper understanding of the role of strain in the epitaxy of metastable GeSn semiconductors.

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Strained semiconductor heterostructures provide a rich playground for investigating the epitaxy of lattice-mismatched materials.1 In the last few decades, SiGe alloys grown with a graded composition on Si were extensively studied to relieve strain by nucleating misfit dislocations in the buffer layers.1–3 Recently, direct bandgap and metastable GeSn alloys gained tremendous interest as a platform for Si-compatible photonics operating at mid-infrared wavelengths.4–7 In unstrained GeSn, the direct bandgap is achieved at Sn contents higher than 10 at. % and hence well above the ~1 at. % equilibrium solubility of Sn in Ge. The incorporation of Sn is highly sensitive to the “in-plane” strain that the GeSn layer experiences during growth.10,11 Due to the large lattice mismatch between α-Sn and Si (~20%), the growth of GeSn layers has been developed on high-quality Ge-virtual substrates (Ge-VS) on Si12,13. Partial strain relaxation can induce compositional grading in GeSn,14–16 eventually leading to segregation and precipitation of Sn, compromising material quality.17–19 In GeSn layers grown on Ge-VS, the compressive strain is reduced in a multi-layer buffered heterostructure grown with different Sn contents by controlling the growth temperature20,21 and precursor flows.22 The high amount of strain induces nucleation of dislocations in the low (7–11 at. %) Sn content buffer layers,11,23 and the resulting uniform (plastic) strain relaxation enhances the Sn incorporation above 16 at. % in the GeSn layers grown on top.24–26 One-dimensional nanowires (NWs) provide additional degrees of freedom in tuning the effect of strain in the growth of lattice-mismatch heterostructures14,27 when using a core/ shell NW geometry.28 The shell displays an increasing strain relaxation with the thickness provided by the free surfaces at the sidewalls, while the elastic compliance of the NW core allows for enhanced strain relaxation in the shell, accommodating the lattice mismatch of the system and avoiding bending.29–31 Recent studies on Ge/GeSn core/shell NWs32,33,34,35 are mainly focused on small Ge core-sizes, where a low amount of residual strain is induced in the GeSn shell.
In this letter, we show how strain can be engineered by tuning the core and shell sizes and we explore high strain conditions focusing on large cores and high Sn contents. To this purpose, core diameters ranging from 50 nm to 100 nm are considered for the growth of the GeSn shell, and the samples are analyzed using transmission electron microscopy (TEM) to assess the crystal quality and the Sn incorporation. Realistic Finite Element Method (FEM) simulations are then performed to characterize the strain distribution in the grown samples and to correlate strain partitioning with NW geometry.

The vapor-liquid-solid (VLS) growth of Au-catalyzed arrays of Ge/GeSn core/shell NWs is performed in a chemical vapor deposition (CVD) reactor using germane (GeH₄), tin-tetrachloride (SnCl₄), and hydrogen chloride (HCl) as precursors (supplementary material S1). The two-temperature step growth is held at 320 °C and 300 °C for the Ge core and GeSn shell growth, respectively. Three different NW arrays with Ge core diameters of 50 nm, 65 nm, and 100 nm were fabricated by controlling the Au layer thickness during nanoimprint lithography.

The scanning electron microscopy (SEM) image in Fig. 1(a) shows an array of Ge/GeSn core/shell NWs grown using a 50 nm core. Tapered top sections and flat [112] sidewalls are obtained, as previously discussed in Refs. 15 and 16. An important feature distinguishable in the bottom section of the NWs is a more complex faceting of the shell morphology, which was reported to be more evident in the bottom section of the NWs (supplementary material S3). The extension and morphology of the multifaceted bottom section are strongly influenced by the diameter of the Ge core, either defined by the size of the Au droplet, or resulting from the small tapering at the NW base. When the Ge core diameter is increased from 50 nm to 65 nm, the length of the multifaceted bottom section extends to more than half of the NW length [Fig. 1(b)]. With a further increase in the Ge core diameter to 100 nm, the shell becomes multifaceted [Fig. 1(c)] and its thickness decreases from ~110 nm to ~60 nm. We note that the thickness of the GeSn shell grown around the 100 nm Ge core is less than one half as compared to when using 50 nm cores. In addition, a small degree of tapering is always observed in the Ge core NW arrays, independently of the diameter (supplementary material S2). Therefore, the reduction in the shell thickness and volume with the development of a multifaceted sidewall is associated with the increase in the Ge core diameter. This suggests strain-driven growth kinetics during GeSn shell growth, which is a similar situation to what is observed in the growth of GeSn in a planar geometry. Furthermore, the HCl supply during the growth of the GeSn shell does not contribute to the change in the morphology in the bottom section of the NWs (supplementary material S3).

A detailed insight into the irregular morphology of the GeSn shell grown using 100 nm Ge cores is obtained using transmission electron microscopy (STEM). The GeSn shell is visible in the energy-dispersive X-ray (EDX) compositional map acquired in scanning-TEM (STEM) mode in Fig. 2(a). No axial growth of a GeSn segment is observed, while a GeSn shell with a variable thickness and a multifaceted sidewall is visible in the TEM images in Figs. 2(b)–2(d). This faceting cannot be related to the core morphology, as the 100 nm Ge-core NWs have flat sidewalls, similar to the 50 nm cores (supplementary material S1). Moreover, the sidewall faceting does not correlate with the Stranski-Krastanov (SK) instability that is observed in Si/Ge core/shell NWs. The low growth temperature (320 °C) and the low(compressive) strain below 1% are not sufficient to trigger the SK instability. Thus, the change in shell morphology between the flat sidewall observed for 50 nm cores and the multifaceted sidewall with 100 nm cores most likely relates to the larger amount of strain in the shell, as we will quantify in the following. Higher strain beyond a critical value leads to plastic relaxation, with the nucleation of defects in the core/shell NW heterostructure. Few defects are indeed visible in the core/shell NW in Figs. 2(b)–2(d), as indicated by the red arrows. Due to the large sample thickness, a precise identification of the type of defects in the shell, such as partial dislocations, is not possible. It is important to compare this situation with the NWs grown using a 50 nm Ge core, where no defect lines were identified in the ~120 nm thick GeSn shell. In the growth of the GeSn shell around 100 nm Ge cores, multiple defects can be identified in the GeSn shell with a thickness of only ~60 nm. Thus, the plastic relaxation in the shell at a smaller thickness and similar Sn content indicates that larger strain energy is present in the core/shell NW during the growth using larger Ge cores. Cross-sectional EDX measurements were performed to determine the distribution of Sn across the shell thickness. In the case of 50 nm Ge cores, the GeSn shell exhibits a hexagonal shape bounded by [112] facets and nm-thin, Sn-poor sunburst stripes along the vertical axis. On the contrary, as shown in Fig. 3, 100 nm-core NWs have a more irregular morphology with both [112] and [110] facets. Also, the composition becomes inhomogeneous, with a Sn content up to ~21 at. % along the radial (112) directions and up to ~10 at. % along the radial (110) directions. The precise shape and composition profiles...
are found to strongly depend on the actual growth conditions, i.e., SnCl$_4$ precursor flow. A detailed understanding of this complex behavior, mostly influenced by the Sn incorporation dynamics, is beyond the scope of the present letter and will be addressed in a separate work.

We now focus on the characterization of the residual strain in the GeSn shell. A quantitative determination of the strain distribution in cross-sectional TEM samples using electron diffraction is challenging.\cite{16} Strain imaging in TEM would require both compositional mapping and lattice periodicity mapping on the nanometer scale because of the inhomogeneous Sn incorporation in the GeSn shell. To circumvent this problem, we use a different strategy by estimating the elastic strain relaxation in the core/shell NW system by FEM simulations.\cite{16} The NW is modeled as a dodecagonal Ge core, along the [111] direction, surrounded by the GeSn shell bounded by six main {112} facets and six smaller {110} ones, perpendicular to the substrate (supplementary material S4). The Sn composition is set differently along the NW deformation. The inner part of the shell, having a smaller volume and a lower Sn composition, may exhibit even a tensile strain, behaving, in the initial stages of deposition, the shell grows pseudomorphically relaxing only through a slight expansion toward the lateral free surfaces. When the shell becomes thicker, the elastic budget is large enough to induce the deformation of the core along the axial direction, resulting in a large decrease in the residual strain. This strain partitioning mechanism is less effective for the largest cores. Indeed, a large increase in the in-plane compressive strain from $-0.3\%$ to $-0.9\%$ is predicted when changing the Ge core diameter from 20 nm to 100 nm at a constant GeSn shell thickness of 20 nm. Thus, an increase in the overall strain energy in the core/shell system with the increasing Ge core diameter is present, which is also maintained at larger shell thicknesses. The enhanced relaxation provided by the lateral expansion along the NW axis allows the accommodation of more Sn, resulting in an increased incorporation of Sn as the shell grows larger.\cite{16} Since the Sn composition is not uniform, the evaluation of the residual strain is not simply related to the relative volume of the core and the shell. Therefore, FEM simulations are strictly required for a precise estimation of the NW deformation. The inner part of the shell, having a lower Sn composition, may exhibit even a tensile strain, behaving, in the same way as the Ge core, as a compliant substrate for the outer shell which has a larger volume and a stronger tendency to expand, because of the higher Sn content. This is particularly evident in the color map in Fig. 4(b) for the NW with the smallest Ge core (20 nm), which can be easily deformed by the surrounding GeSn shell. The computed axial strain averaged in the core volume is plotted in Fig. 4(d) as a function of the GeSn shell thickness, for different core diameters (10 nm increment). A linear composition gradient along the {112} direction from 9 at. % up to 18 at. % Sn for a 60 nm-thick shell (7 at. % to 10 at. % Sn along the {110} direction) is assumed to match the experiments. Solid lines correspond to the NW of Fig. 3.

![Color map of the radial, tangential, and axial FEM strain components for a 100 nm core diameter and a 60 nm-thick shell. (b) Axial strain for a 20/60 nm Ge/GeSn core/shell NW heterostructure. (c) and (d) In-plane strain (average of tangential and axial) at the shell surface (c) and axial strain in the Ge core (d) as a function of the shell thickness, for different core diameters (10 nm increment). A linear composition gradient along the {112} direction from 9 at. % up to 18 at. % Sn for a 60 nm-thick shell (7 at. % to 10 at. % Sn along the {110} direction) is assumed to match the experiments. Solid lines correspond to the NW of Fig. 3.](image)
the strain accumulation in the shell is likely to exceed the onset of plastic relaxation, with the development of extended defects, partially relieving strain [Figs. 2(c)–2(d)]. In addition, the critical thickness should be larger than in (not compliant) planar substrates; still, the circular periodicity induced by the tubular configuration of the shell is likely to affect the nucleation and multiplication mechanisms of misfit dislocations. This issue would require a detailed HRTEM analysis, not presently viable, as explained above. Finally, we note that a tensile axial strain above 2% in the 20 nm Ge core can be achieved at a GeSn shell thickness larger than 60 nm [Fig. 4(d)], which could eventually induce an indirect to direct bandgap transition in the Ge core, thus enriching the physical properties of a fully integrated group-IV semiconductor optoelectronic platform.

In conclusion, the growth of GeSn alloys in a Ge/GeSn core/shell NW heterostructure shows few striking differences with respect to conventional planar growth. In the latter, the uniform plastic relaxation allows for enhanced Sn incorporation beyond the dislocated region while keeping a limited surface roughness (<10 nm). When using Ge/GeSn core/shell NWs, competing strain relaxation between the (fewer) more geometrically constrained defects and the nonuniform Sn distribution on the {110}–{112} facets takes place. Therefore, the growth of GeSn alloys in a core/shell NW geometry is beneficial when the strain in the shell is kept below the threshold for plastic relaxation and hence when using thinner (50 nm) Ge cores. On the contrary, for larger (100 nm) Ge cores, the higher strain in the shell induces a more irregular growth of the GeSn shell, affected by both structural imperfections (multifaceted and rotated sidewalls and defects) and compositional inhomogeneities. These results show the critical role of strain in the growth of GeSn alloys, which can be further investigated with the development of SiGeSn alloys for enhanced strain and bandgap engineering.

See the supplementary material for additional information on the growth conditions, structural characterization, and FEM simulations.

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REFERENCES